FAIRCHILD SEMICONDUCTOR®

December 2008

SuperFET™

FCA20N60F

600V N-CHANNEL FRFET

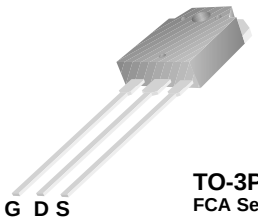
Features

- 650V @T_J = 150°C
- Typ. Rds(on)=0.15Ω
- Fast Recovery Type (t_{rr} = 160ns)
- Ultra low gate charge (typ. Qg=75nC)
- Low effective output capacitance (typ. Coss.eff=165pF)
- 100% avalanche tested
- RoHS Compliant

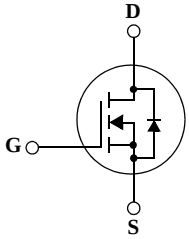
Description

SuperFET™ is, Fairchild's proprietary, new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET is very suitable for various AC/DC power conversion in switching mode operation for system miniaturization and higher efficiency.



TO-3PN
FCA Series



Absolute Maximum Ratings

Symbol	Parameter		FCA20N60F	Unit
V_{DSS}	Drain-Source Voltage		600	V
I_D	Drain Current	- Continuous (T_C = 25°C) - Continuous (T_C = 100°C)	20 12.5	A A
I_{DM}	Drain Current	- Pulsed (Note 1)	60	A
V_{GSS}	Gate-Source voltage		± 30	V
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	690	mJ
I_{AR}	Avalanche Current	(Note 1)	20	A
E_{AR}	Repetitive Avalanche Energy	(Note 1)	20.8	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	50	V/ns
P_D	Power Dissipation	(T_C = 25°C) - Derate above 25°C	208 1.67	W W/°C
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T_L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		300	°C

Thermal Characteristics

Symbol	Parameter	FCA20N60F	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.6	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	40	°C/W

* When mounted on the minimum pad size recommended (PCB Mount)

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCA20N60F	FCA20N60F	TO-3PN	--	--	30

Electrical Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0V, I_D = 250μA, T_J = 25°C	600	--	--	V
		V_{GS} = 0V, I_D = 250μA, T_J = 150°C	--	650	--	V
ΔBV_{DSS} / ΔT_J	Breakdown Voltage Temperature Coefficient	I_D = 250μA, Referenced to 25°C	--	0.6	--	V/°C
BV_{DSS}	Drain-Source Avalanche Breakdown Voltage	V_{GS} = 0V, I_D = 20A	--	700	--	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 600V, V_{GS} = 0V V_{DS} = 480V, T_C = 125°C	-- --	-- --	10 100	μA μA
I_{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = 30V, V_{DS} = 0V	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = -30V, V_{DS} = 0V	--	--	-100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250μA	3.0	--	5.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	V_{GS} = 10V, I_D = 10A	--	0.15	0.19	Ω
g_{FS}	Forward Transconductance	V_{DS} = 40V, I_D = 10A (Note 4)	--	17	--	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz	--	2370	3080	pF
C_{oss}	Output Capacitance		--	1280	1665	pF
C_{rss}	Reverse Transfer Capacitance		--	95	--	pF
C_{oss}	Output Capacitance	V_{DS} = 480V, V_{GS} = 0V, f = 1.0MHz	--	65	85	pF
C_{oss} eff.	Effective Output Capacitance	V_{DS} = 0V to 400V, V_{GS} = 0V	--	165	--	pF
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 300V, I_D = 20A, R_G = 25Ω	--	62	135	ns
t_r	Turn-On Rise Time		--	140	290	ns
$t_{d(off)}$	Turn-Off Delay Time		--	230	470	ns
t_f	Turn-Off Fall Time	(Note 4, 5)	--	65	140	ns
Q_g	Total Gate Charge	V_{DS} = 480V, I_D = 20A, V_{GS} = 10V	--	75	98	nC
Q_{gs}	Gate-Source Charge		--	13.5	18	nC
Q_{gd}	Gate-Drain Charge	(Note 4, 5)	--	36	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain-Source Diode Forward Current		--	--	20	A
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	60	A
V_{SD}	Drain-Source Diode Forward Voltage	V_{GS} = 0V, I_S = 20A	--	--	1.4	V
t_{rr}	Reverse Recovery Time	V_{GS} = 0V, I_S = 20A, dI_F/dt =100A/μs (Note 4)	--	160	--	ns
Q_{rr}	Reverse Recovery Charge		--	1.1	--	μC

NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. I_{AS} = 10A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C
3. I_{SD} ≤ 20A, di/dt ≤ 1200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C
4. Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 2%
5. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

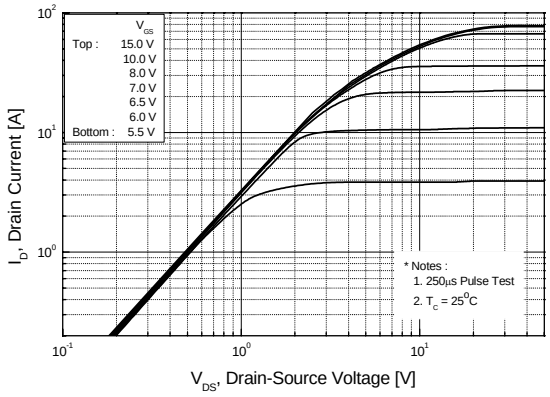


Figure 2. Transfer Characteristics

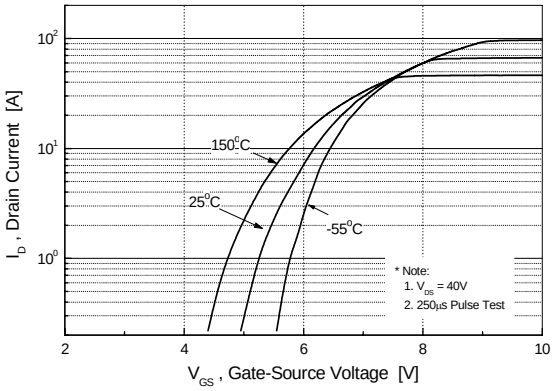


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

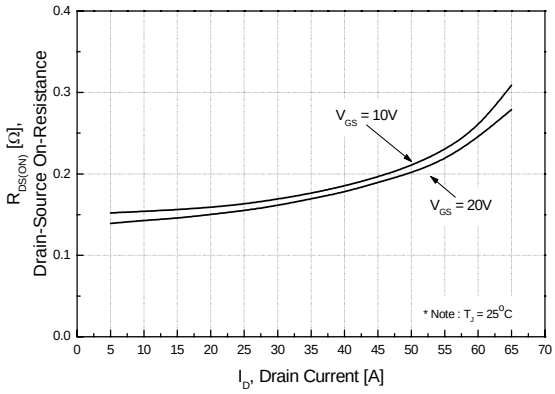


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperatue

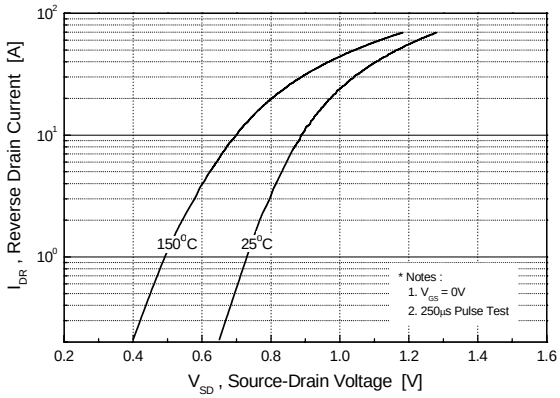


Figure 5. Capacitance Characteristics

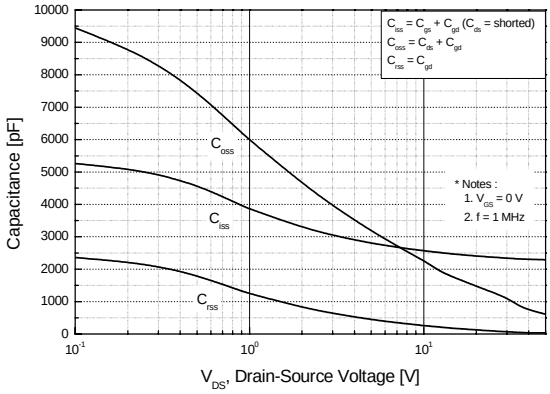
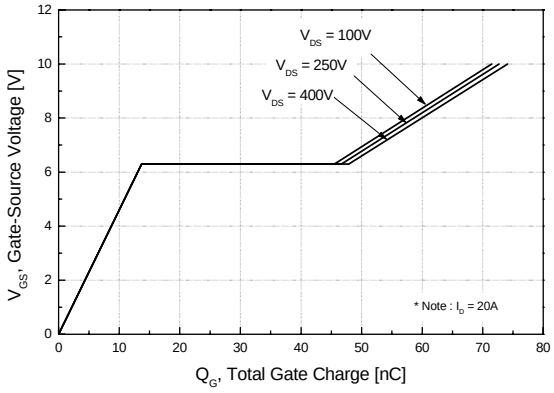


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

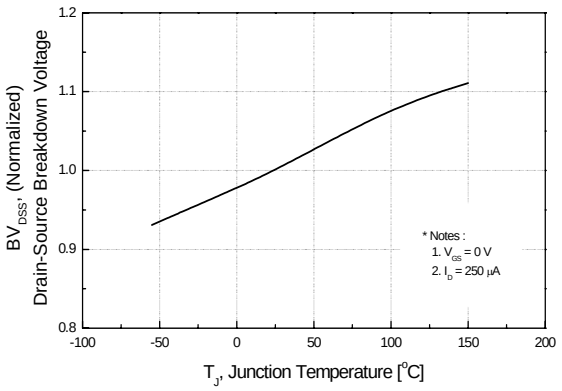


Figure 8. On-Resistance Variation vs. Temperature

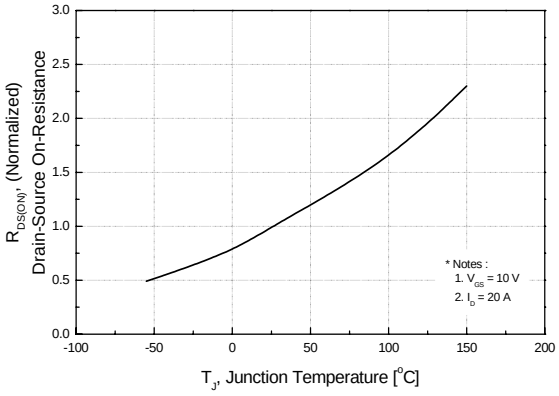


Figure 9-1. Maximum Safe Operating Area

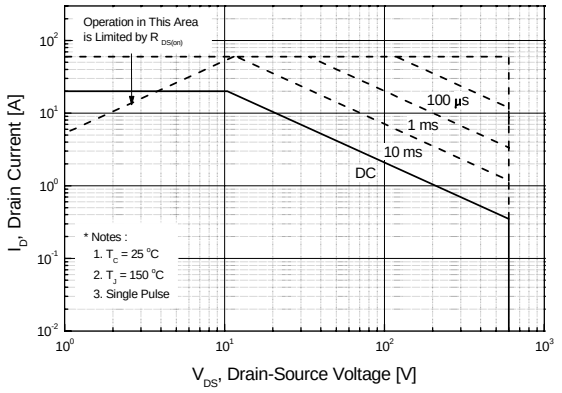


Figure 10. Maximum Drain Current vs. Case Temperature

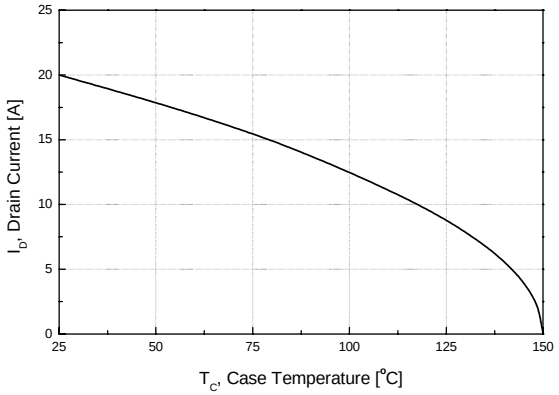
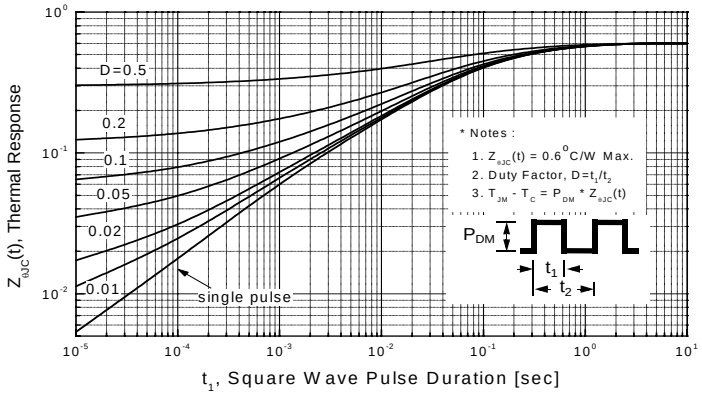
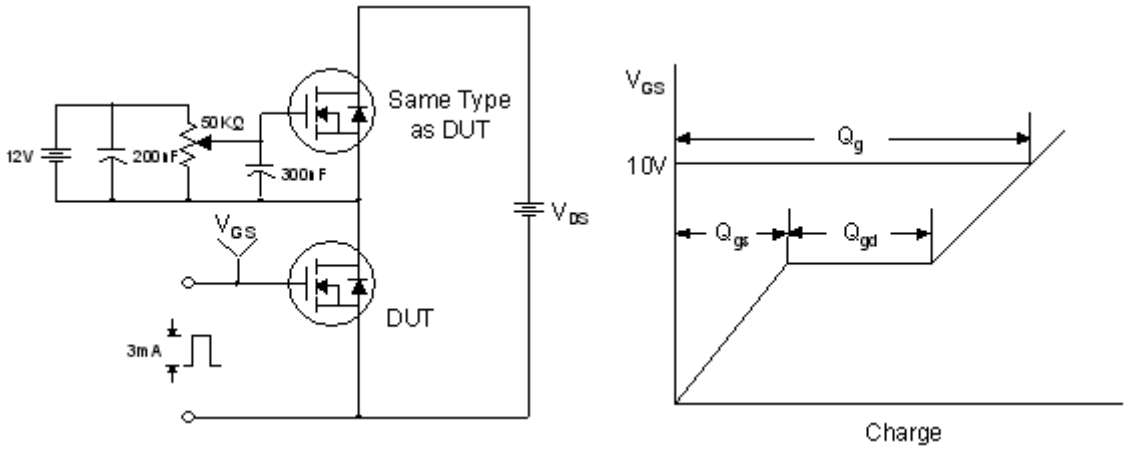


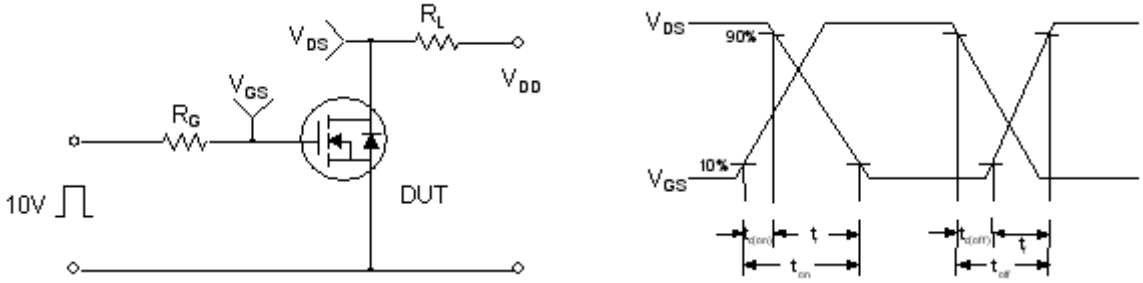
Figure 11. Transient Thermal Response Curve



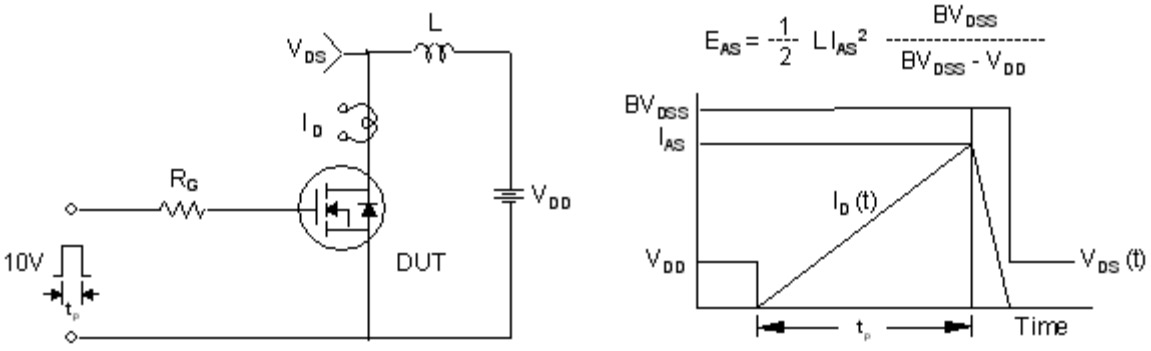
Gate Charge Test Circuit & Waveform



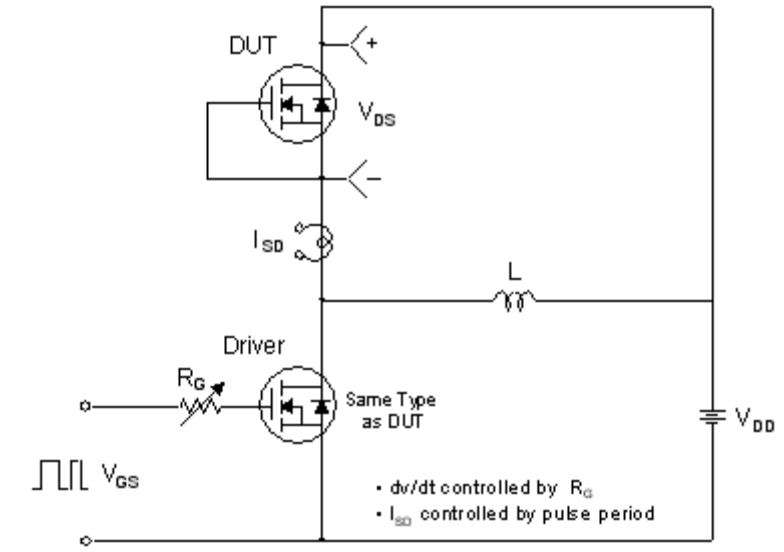
Resistive Switching Test Circuit & Waveforms

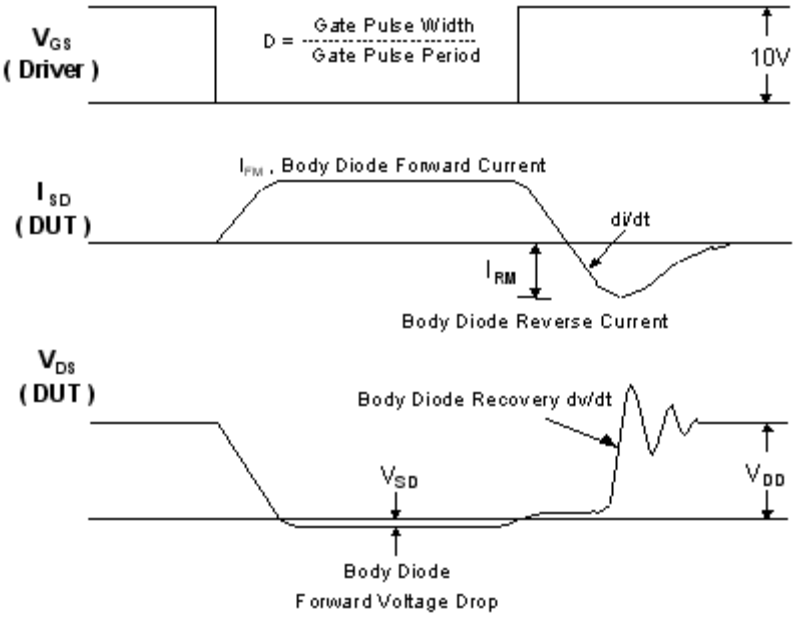


Unclamped Inductive Switching Test Circuit & Waveforms



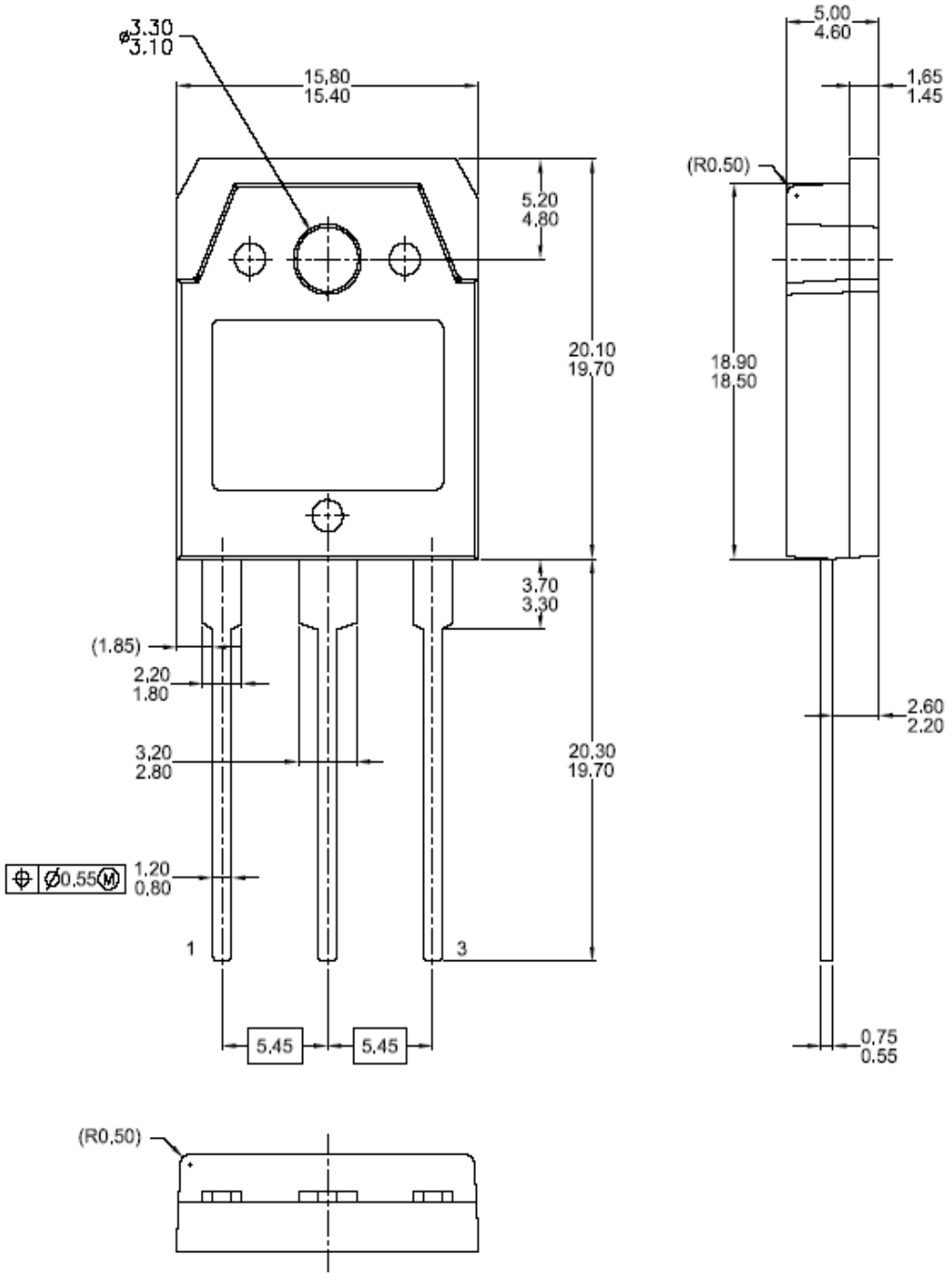
Peak Diode Recovery dv/dt Test Circuit & Waveforms





Mechanical Dimensions

TO-3PN



Dimensions in Millimeters

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